

**1-Line, Bi-directional, Transient Voltage Suppressors**

**Descriptions**

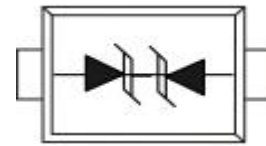
The ESD33A200TA is a bi-directional TVS (Transient Voltage Suppressor). It is specifically designed to protect sensitive electronic components that may be subjected to ESD (Electrostatic Discharge), EFT (Electrical Fast Transients) and Lightning. It is particularly well-suited for cellular phones, portable device, digital cameras, power supplies and many other portable applications because of its small package and low weight.

The ESD33A200TA may be used to provide ESD protection up to  $\pm 30\text{kV}$  air discharge  $\pm 30\text{kV}$  contact discharge according to IEC61000 - 4 - 2 , and withstand peak pulse current up to 7.0 A (8/20 $\mu\text{s}$ ) according to IEC61000-4-5.

The ESD33A200TA is available in SOD-323 package. Standard products are Pb-free and Halogen-free.



**SOD-323**



**Circuit diagram**

**Features**

- Stand-off voltage:  $\pm 33\text{VMax}$
- Transient protection for each line according to IEC61000-4-2 (ESD):  $\pm 30\text{kV}$  air discharge  $\pm 30\text{kV}$  contact discharge IEC61000-4-5 (surge): 7.0A(8/20 $\mu\text{s}$ )
- Solid-state silicon technology

**Applications**

- Cell phone handsets and accessories
- Personal Digital Assistants (PDAs)
- Notebooks, Desktops, and Servers
- Portable Instrumentation
- Digital Cameras
- MID/CAR DVD/MP3/MP4/PMP Players

**Order information**

Device	Package	Shipping	Mark
ESD33A200TA	SOD-323	3000/Tape&Reel	2M

**Absolute maximum ratings**

Parameter	Symbol	Rating	Unit
Peak pulse current ( $t_p = 8/20\mu s$ )	$I_{PP}$	7.0	A
ESD according to IEC61000-4-2 air discharge	$V_{ESD}$	$\pm 30$	kV
ESD according to IEC61000-4-2 contact discharge		$\pm 30$	
Operation junction temperature	$T_J$	-55~150	$^{\circ}C$
Lead temperature	$T_L$	260	$^{\circ}C$
Storage temperature	$T_{STG}$	-55~150	$^{\circ}C$

**Electrical characteristics (TA=25 °C ,unless otherwise noted)**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	$V_{RWM}$				$\pm 33.0$	V
Reverse leakage current	$I_R$	$V_{RWM} = 33.0V$			1.0	$\mu A$
Reverse breakdown voltage	$V_{BR}$	$I_T = 1mA$	34.5			V
Clamping voltage	$V_C$	$I_{pp} = 1A$ $t_p = 8/20\mu s$			45.5	V
		$I_{pp} = 7.0A$ $t_p = 8/20\mu s$			58.0	V
Junction capacitance	$C_J$	$V_R = 0V, f = 1MHz$		20.0	50.0	pF

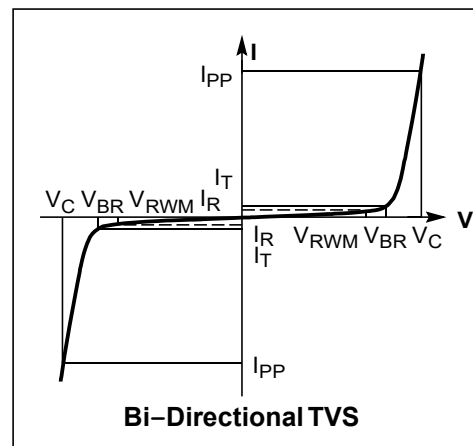
**Electrical performance curve**

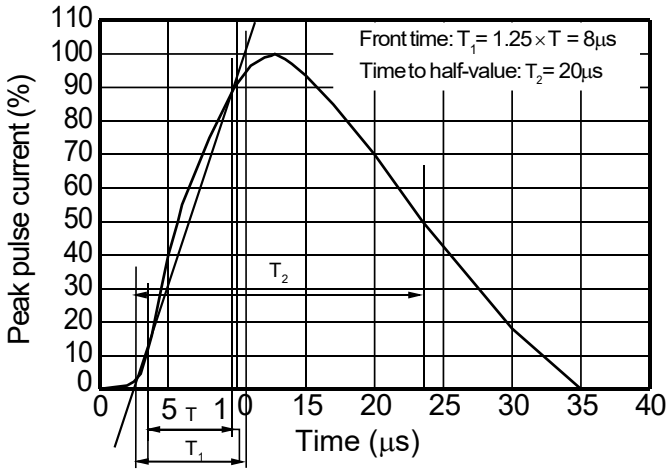
$V_C$  : Maximum clamping voltage

$V_{br}$  : Reverse breakdown voltage

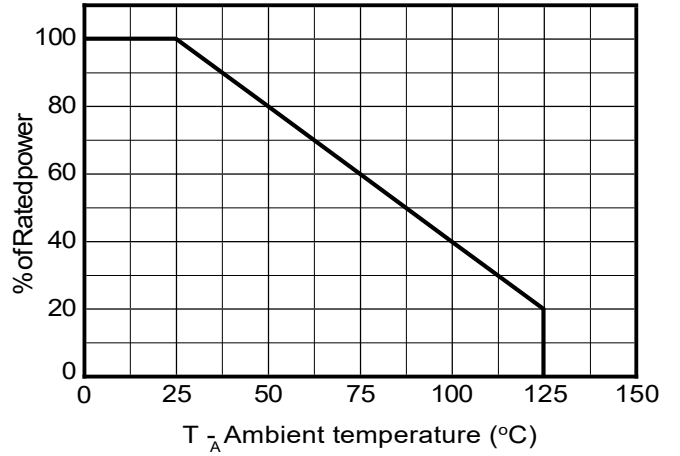
$V_{RWM}$  : Working voltage

$I_{PP}$  : Maximum peak current

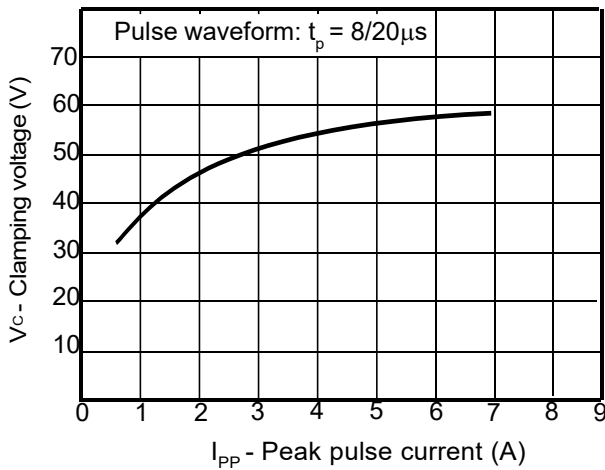




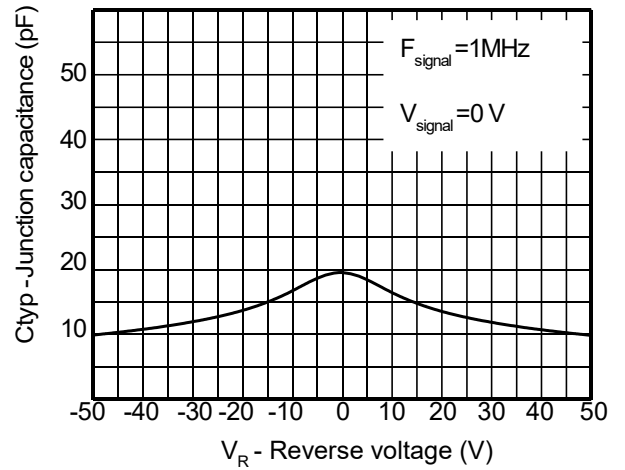
8/20 $\mu\text{s}$  waveform per IEC61000-4-5



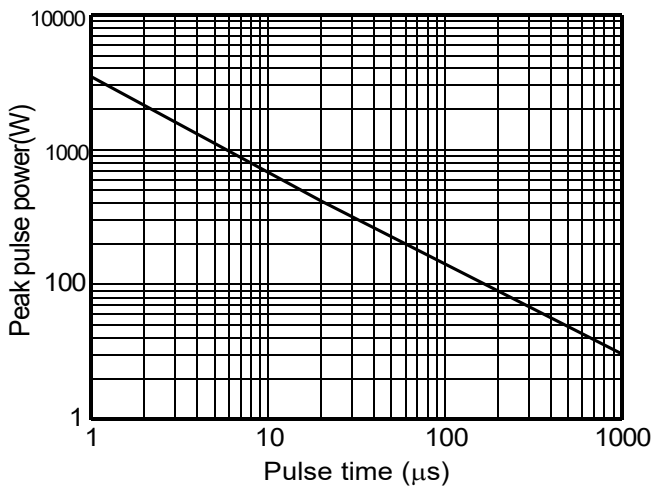
Power derating vs. Ambient temperature



Clamping voltage vs. Peak pulse current

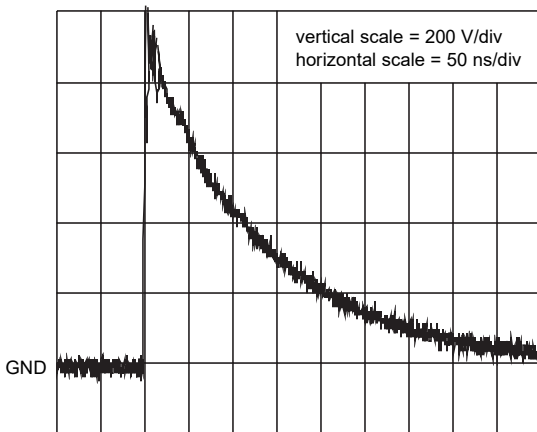
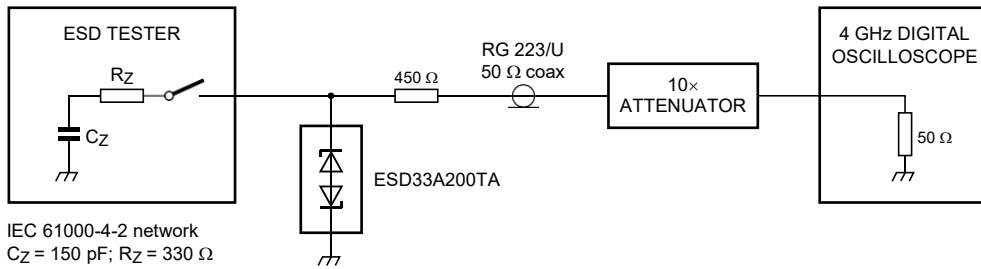


Capacitance vs. Reverse voltage

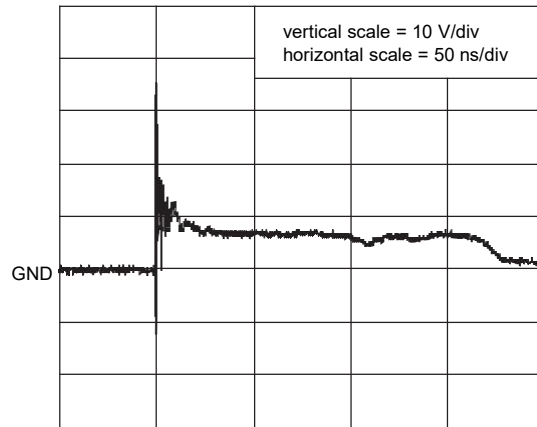


Non-repetitive peak pulse power vs. Pulse time

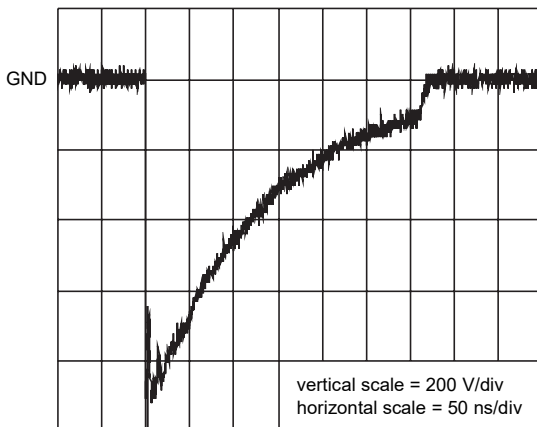
ESD clamping test setup and waveforms



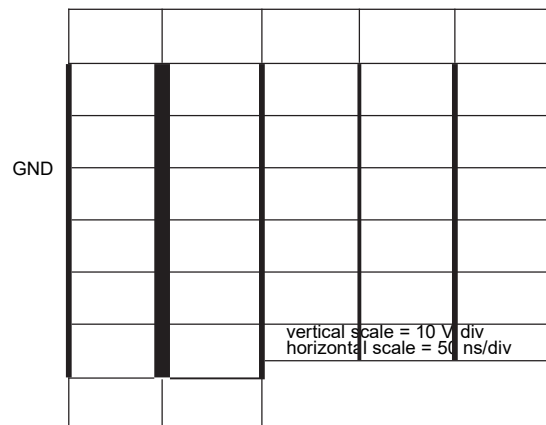
unclamped +1 kV ESD voltage waveform  
(IEC61000-4-2 network)



clamped +1 kV ESD voltage waveform  
(IEC61000-4-2 network)



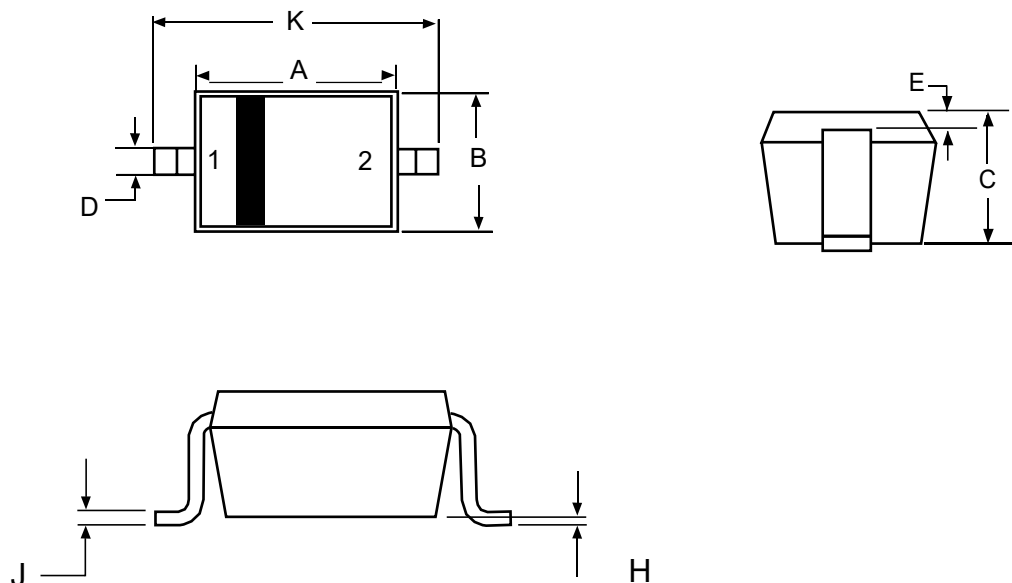
unclamped -1 kV ESD voltage waveform  
(IEC61000-4-2 network)



clamped -1 kV ESD voltage waveform  
(IEC61000-4-2 network)

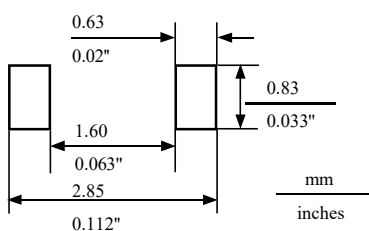
Package outline dimensions

SOD-323



Symbol	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	1.60	1.80	0.063	0.071
B	1.15	1.35	0.045	0.053
C	0.80	1.00	0.031	0.039
D	0.25	0.40	0.010	0.016
E	0.15 REF		0.006 REF	
H	0.00	0.10	0.000	0.004
J	0.089	0.177	0.0035	0.0070
K	2.30	2.70	0.091	0.106

Recommend land pattern (Unit: mm)



Note: This land pattern is for your reference only. Actual pad layouts may vary depending on application.